



Parameter	Rating	Units
AC Operating Voltage	120	V <sub>rms</sub>
Load Current	1	A <sub>rms</sub>
On-State Voltage Drop (I <sub>L</sub> =1A <sub>rms</sub> )	1.2	V <sub>rms</sub>

### Features

- Load Current up to 1A<sub>rms</sub>
- Blocking Voltages up to 400V<sub>P</sub>
- 3750V<sub>rms</sub> Input to Output Isolation
- 5mA Sensitivity
- Zero-Crossing Detection
- DC Control, AC Output
- Optically Isolated
- TTL and CMOS Compatible
- Low EMI and RFI Generation
- High Noise Immunity
- VDE compatible
- Machine Insertable, Wave Solderable

### Applications

- Programmable Control
- Process Control
- Power Control Panels
- Remote Switching
- Gas Pump Electronics
- Contactors
- Large Relays
- Solenoids
- Motors
- Heaters

### Description

The PD1201 is an AC Solid State Switch using optical coupling with dual power SCR outputs to produce an alternative to optocoupler and Triac circuits. The PD1201 switches are robust enough to provide a blocking voltage of up to 400V<sub>P</sub> and max surge current rating of 20A. In addition, tightly controlled zero-cross circuitry ensures switching of AC loads without the generation of transients. The input and output circuits are optically coupled to provide 3750V<sub>rms</sub> of isolation and noise immunity between control and load circuits. As a result the PD1201 is well suited for industrial environments where electromagnetic interference would disrupt the operation of electromechanical relays.

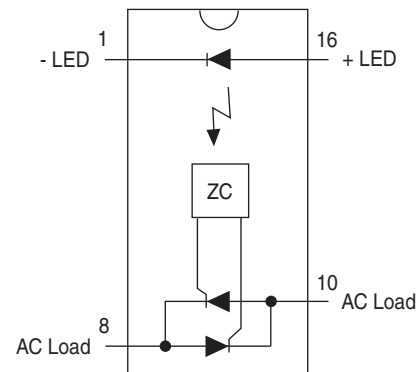
### Approvals

- UL Recognized Component: UL 508 File E69938
- CSA Certified Component: File 043639

### Ordering Information

Part #	Description
PD1201	4-Pin (16-Pin Body) DIP Package (25/Tube)

### Pin Configuration



**Absolute Maximum Ratings @ 25°C**

Parameter	Min	Max	Units
Blocking Voltage	-	400	V <sub>P</sub>
Reverse Input Voltage	-	5	V
Input Control Current	-	100	mA
Peak (10ms)	-	1	A
Input Power Dissipation <sup>1</sup>	-	150	mW
Total Package Dissipation <sup>2</sup>	-	1600	mW
Isolation Voltage, Input to Output	3750	-	V <sub>rms</sub>
Operational Temperature	-40	+85	°C
Storage Temperature	-40	+125	°C

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

<sup>1</sup> Derate linearly 1.33 mW / °C

<sup>2</sup> Derate linearly 16.6 mW / °C

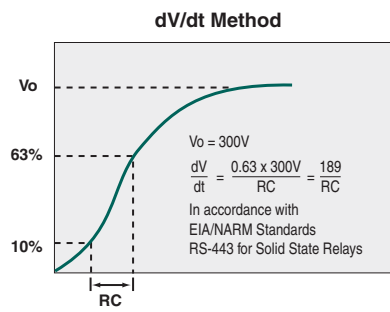
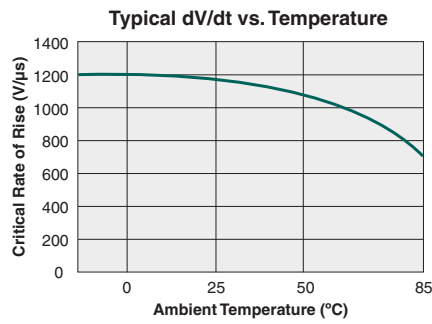
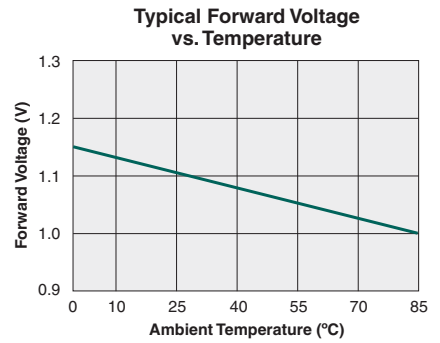
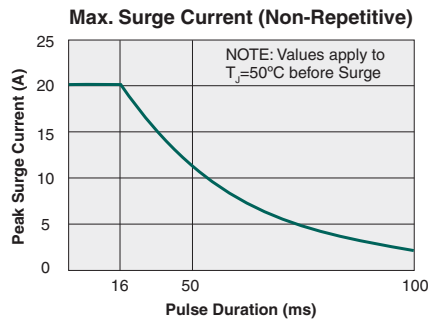
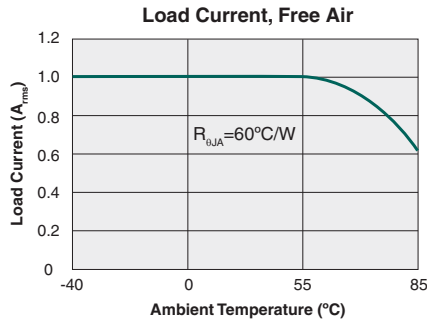
**Electrical Characteristics @ 25°C**

Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
AC Operating Voltage	I <sub>F</sub> =5mA	V <sub>OP</sub>	20	-	120	V <sub>rms</sub>
Load Current (Continuous)	V <sub>L</sub> =120-240VAC	I <sub>L</sub>	0.005	-	1	A <sub>rms</sub>
Maximum Surge Current	t <sub>≤</sub> 16ms	I <sub>PEAK</sub>	-	-	20	A
Off-State Leakage Current	V <sub>L</sub> =400V <sub>DC</sub>	I <sub>LEAK</sub>	-	-	1	mA
On-State Voltage Drop	I <sub>L</sub> =1.0A <sub>rms</sub>	-	-	-	1.2	V <sub>rms</sub>
Critical Rate of Rise	-	dV/dt	1000	1200	-	V/μs
Switching Speeds						
Turn-On	I <sub>F</sub> =5mA	t <sub>on</sub>	-	-	0.5	Cycles
Turn-Off		t <sub>off</sub>	-	-	0.5	
Zero-Cross Turn-On Voltage <sup>1</sup>	1 <sup>st</sup> half-cycle	-	-	2	5	V
	Subsequent half-cycle	-	-	-	1	V
Operating Frequency	-	-	20	-	500	Hz
Load Power Factor for Guaranteed Turn-On <sup>2</sup>	-	PF	0.25	-	-	-
Capacitance Input-To-Output	-	C <sub>I/O</sub>	-	3	-	pF
<b>Input Characteristics</b>						
Input Control Current						
For Normal Environment	-	I <sub>F</sub>	-	-	5	mA
For High Noise Environment	-		-	-	10	
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Input Dropout Voltage	-	-	0.8	-	-	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA

<sup>1</sup> Zero Cross 1<sup>st</sup> half-cycle @ < 100Hz.

<sup>2</sup> Snubber circuits may be required at low power factors.

PERFORMANCE DATA @ 25°C (Unless Otherwise Noted) \*



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

**Manufacturing Information**

**Moisture Sensitivity**



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
PD1201	MSL 1

**ESD Sensitivity**



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

**Reflow Profile**

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
PD1201	245°C for 30 seconds

**Board Wash**

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

